

	Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors	Ref #
1	BRS	8	bump\$4 near mushroom and bump with copper	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/25 10:50				S2
2	BRS	4	bump\$4 near mushroom and bump with copper and stem	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/21 12:10				S3
3	BRS	5	bump\$4 with stem and bump with ellip\$6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/21 10:20				S4
4	BRS	45	bump with ellip\$6 and semiconductor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/21 08:27				S6
5	BRS	9	bump with ellip\$6 and semiconductor and bump with copper	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/21 08:16				S7
6	BRS	4	bump and ellip\$6 and semiconductor and stem and mushroom	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/21 08:28				S10
7	BRS	51	bump and ellip\$6 and semiconductor and stem	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/21 08:44				S9
8	BRS	6	bump\$4 with stem and bump with elongat\$6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/21 08:53				S11
9	BRS	3	bump\$4 with stem and (copper or cu) and ellip\$6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/21 10:20				S13

	Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors	Ref #
10	BRS	19	bump\$4 with stem and bump and ellip\$6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/21 11:44				S12
11	BRS	4	bump\$4 with mushroom and bump same ellip\$6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/21 12:50				S14
12	BRS	27	bump near ellip\$6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/21 11:27				S15
13	BRS	5	bump\$4 with stem and bump with ellip\$6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/21 11:45				S16
14	BRS	5	bump\$4 with stem and bump same ellip\$6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/21 11:45				S17
15	BRS	11	bump\$4 same stem and bump same ellip\$6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/21 11:45				S18
16	BRS	5	bump near ellip\$6 and semiconductor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/21 11:46				S19
17	BRS	1	2002-374912.NRAN.	DERWENT	2005/03/21 11:52				S20
18	BRS	2	bump\$4 near mushroom and stem near (circ\$5 or round or cylind\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/21 11:57				S21

	Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors	Ref #
19	BRS	6	bump\$4 near mushroom and stem with (circ\$5 or round or cylind\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/21 11:58				S22
20	BRS	3	bump\$4 near mushroom and stem with (circul\$5 or round or cylind\$5 or circl\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/21 12:51				S23
21	BRS	7	bump\$4 with mushroom and stem with (circul\$5 or round or cylind\$5 or circl\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/21 11:59				S24
22	BRS	52	bump\$4 with stem with (circul\$5 or round or cylind\$5 or circl\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/21 11:59				S25
23	BRS	1	bump\$4 same stem with (circul\$5 or round or cylind\$5 or circl\$5) and semiconductor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/21 12:00				S27
24	BRS	4	bump\$4 near mushroom and bump with stem	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/21 12:11				S28
25	BRS	5	bump\$4 with mushroom and bump with stem	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/21 12:16				S29

	Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors	Ref #
26	BRS	2	bump\$4 same mushroom same ellip\$6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/21 12:17				S30
27	BRS	2	bump\$4 same mushroom same ellip\$6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/24 00:36				S32
28	BRS	14	bump\$4 with mushroom and ellip\$6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/24 00:06				S33
29	BRS	9	bump\$4 with mushroom with stem	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/21 12:52				S34
30	BRS	8	bump\$4 same mushroom same stem same (circul\$5 or round or cylind\$5 or circl\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/21 12:53				S35
31	BRS	7	bump\$4 near mushroom and bump with elongat\$6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/23 23:40				S36
32	BRS	14	bump\$4 with mushroom and bump with elongat\$6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/23 23:40				S37
33	IS&R	2	("6372622").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/24 00:07				S38
34	IS&R	2	("6194667").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/24 00:09				S39

	Type	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors	Ref #
35	IS&R	2	("5523920").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/24 00:09				S40
36	IS&R	2	("4742023").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/24 00:10				S41
37	BRS	2	bump\$4 with mushroom and fine with pitch and ellip\$6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/24 00:11				S43
38	BRS	45	bump\$4 with mushroom and fine with pitch	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/24 00:15				S42
39	BRS	7	bump\$4 and stem with (circul\$5 or round or cylind\$5 or circl\$5) and semiconductor and ellip\$6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/24 00:35				S44
40	BRS	7	bump\$4 near mushroom and axis	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/03/25 10:50				S45